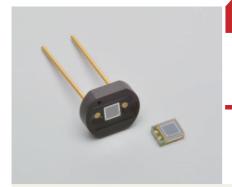


PHOTON IS OUR BUSINESS

MPPC® (Multi-Pixel Photon Counter)



S13720 series

Near infrared MPPC

MPPC is a type of device called SiPM (Silicon Photomultipliers). It is a new type of photon counting device that consists of multiple Geiger mode APD (avalanche photodiode) pixels. It is an opto-semiconductor with outstanding photon counting capability and low operating voltage and is immune to the effects of magnetic fields.

The S13720 series near infrared MPPC provides high photon detection efficiency in the near infrared region.

Features

- Applications
- → High photon detection efficiency (twice that of Hamamatsu S13360 series): 7% (λ=905 nm)
- Low crosstalk
- **■** Small package (S13720-1325PS)
- **→** High gain: 10⁵ to 10⁶

Distance measurement (e.g., LiDAR)

Structure

Parameter	S13720-1325CS	S13720-1325PS	Unit
Effective photosensitive area	1.3 × 1.3		
Pixel pitch	25		
Number of pixels/ch	2668		
Fill factor	47		
Package	Ceramic Surface mount typ		-
Window material	Silicone		-
Refractive index of window material	1.41	1.57	-

■ Absolute maximum ratings

Parameter	Symbol	S13720-1325CS S13720-1325PS		Unit	
Operating temperature*1	Topr	-40 to +85			
Storage temperature*1	Tstg	-40 to +105			
Soldering conditions	Tsol	350 °C max., once, 3 s max	Peak temperature: 260 °C, 3 times*2	2 -	

^{*1:} No dew condensation

When there is a temperature difference between a product and the surrounding area in high humidity environment, dew condensation may occur on the product surface. Dew condensation on the product may cause deterioration in characteristics and reliability.

Note: Exceeding the absolute maximum ratings even momentarily may cause a drop in product quality. Always be sure to use the product within the absolute maximum ratings.

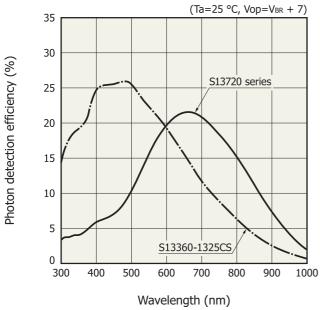
^{*2:} JEDEC level 2a

= Electrical and optical characteristics (Typ. Ta=25 °C, overvoltage=7 V, unless otherwise noted)

Parameter	Condition	Symbol	Min.	Тур.	Max.	Unit
Spectral response range		λ	-	350 to 1000	-	nm
Peak sensitivity wavelength		λр	-	660	-	nm
Photon detection efficiency*3	λ=λρ	- PDE	-	22	-	- %
	λ=905 nm		-	7	-	
Breakdown voltage		VBR	52	57	62	V
Recommended operating voltage*4		Vop	-	VBR + 7	-	V
Dark count		-	-	500	1500	kcps
Crosstalk probability		-	-	6	-	%
Terminal capacitance		Ct	-	65	-	pF
Gain		М	-	1.1×10^{6}	-	-
Temperature coefficient of reverse voltage		ΔΤVορ	-	54	-	mV/°C

^{*3:} Photon detection efficiency does not include crosstalk or afterpulses.

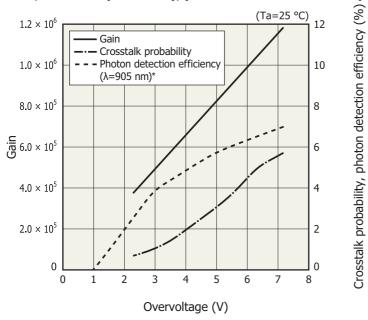
Photon detection efficiency vs. wavelength (typical example)



KAPDB0377EB

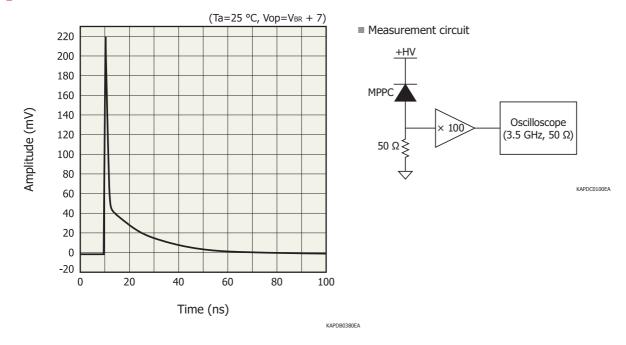
^{*4:} Refer to the label affixed to the product package. Recommended operating voltage variation in-reel products: ±0.25 V/reel

□ Gain, crosstalk probability, photon detection efficiency-overvoltage characteristics (typical example)

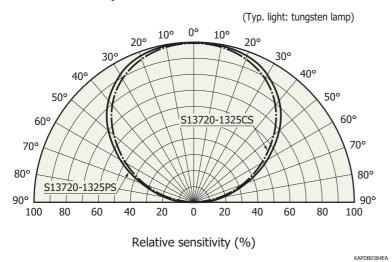


* Converted from photon detection efficiency (λ =660 nm) KAPDB0383EB

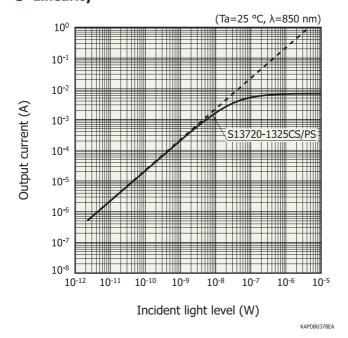
Pulse waveform



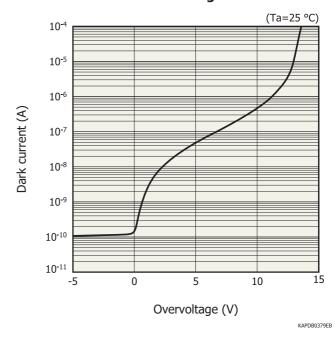
Directivity



Linearity

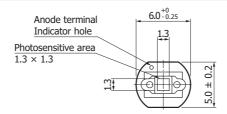


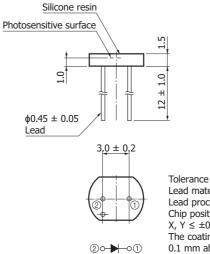
₽ Dark current vs. overvoltage



Dimensional outlines (unit: mm)

S13720-1325CS

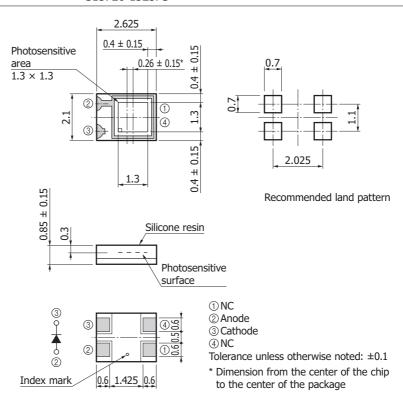




Tolerance unless otherwise noted: ± 0.2 Lead material: Fe-Ni-Co alloy Lead processing: Au plating Chip position accuracy: X, Y $\leq \pm 0.25$ with respect to package center The coating resin may swell a maximum of 0.1 mm above the top of the package.

KAPDA0177EB

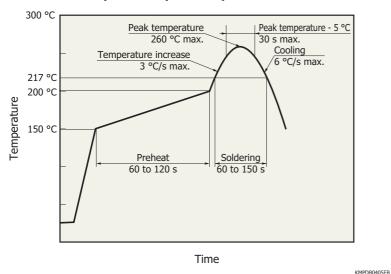
S13720-1325PS



KAPDA0178EA



▶ Measured example of temperature profile with our hot-air reflow oven for product testing (S13720-1325PS)



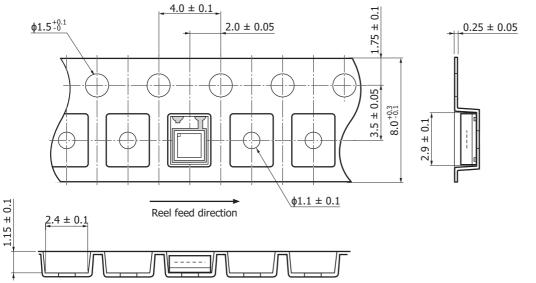
- \cdot This surface mount type package product supports lead-free soldering. After unpacking, store it in an environment at a temperature of 30 °C or less and a humidity of 60% or less, and perform soldering within 4 weeks.
- The effect that the product is subject to during reflow soldering varies depending on the circuit board and reflow oven that are used. When you set reflow soldering conditions, check that problems do not occur in the product by testing out the conditions in advance.

Standard packing specifications (S13720-1325PS)

■ Reel (conforms to JEITA ET-7200)

Dimensions	Hub diameter	Tape width	Material	Electrostatic characteristics
180 mm	60 mm	8 mm	PS	Conductive

■ Embossed tape (unit: mm, material: PS, conductive)



KAPDC0101EA

- Packing quantity 1000 pcs/reel
- Packing type

 Reel and desiccant in moisture-proof packaging (vacuum-sealed)

Related information

www.hamamatsu.com/sp/ssd/doc_en.html

- Precautions
- · Disclaimer
- · Metal, ceramic, plastic packages
- · Surface mount type products

MPPC module C14193-1325SA

The C14193-1325SA is an optical measurement module that can detect low light levels. It consists of an MPPC, a high-speed amplifier circuit, a high-voltage circuit, and a temperature compensation circuit. The built-in small pixel pitch ($25 \mu m$) MPPC S13720-1325CS allows high photon detection efficiency in the near infrared region as well as high-speed measurement and wide dynamic range. The C14193-1325SA runs simply by connecting a single power supply (+5 V).

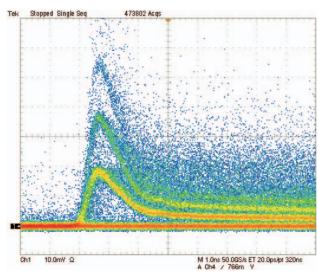
Features

- **Internal MPPC: S13720-1325CS**
- → High-speed response
- Built-in temperature compensation circuit
- Compact and lightweight

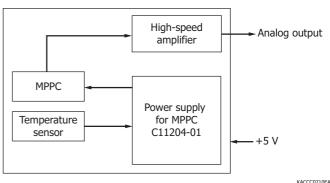


- → Distance measurement (e.g., LiDAR)
- **S13720-1325CS evaluation**

Pulse waveform



Block diagram



KACCCU/1

\$13720 series

MPPC is a registered trademark of Hamamatsu Photonics K.K.

Information described in this material is current as of May 2018.

Product specifications are subject to change without prior notice due to improvements or other reasons. This document has been carefully prepared and the information contained is believed to be accurate. In rare cases, however, there may be inaccuracies such as text errors. Before using these products, always contact us for the delivery specification sheet to check the latest specifications.

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HAMAMATSU PHOTONICS K.K., Solid State Division

HAMAMATSU PHOTONICS K.K., Solid State Division

1126-1 Ichino-cho, Higashi-ku, Hamamatsu City, 435-8558 Japan, Telephone: (81) 53-434-3311, Fax: (81) 53-434-5184

U.S.A.: Hamamatsu Corporation: 360 Foothill Road, Bridgewater, N.J. 08807, U.S.A., Telephone: (1) 908-231-0960, Fax: (1) 908-231-1218, E-mail: usa@hamamatsu.com

Germany: Hamamatsu Photonics Deutschland GmbH: Arzbergerstr. 10, D-82211 Herrsching am Ammersee, Germany, Telephone: (49) 8152-375-0, Fax: (49) 8152-265-8, E-mail: info@hamamatsu.de

France: Hamamatsu Photonics Korden S.A.R.L.: 19, Rue du Saule Trapu, Parc du Moulin de Massy, 91882 Massys Cedex, France, Telephone: 33-(1) 69 53 71 10, Fax: 33-(1) 707-294888, Fax: (49) 1707-294888, Fax: (49) 1807-294888, Fax: (49) 1807-294888, Fax: (49) 1807-29488, Fax: (49) 1807-294888, Fax: (49) 1807-294888,